# FAIRCHILD

SEMICONDUCTOR

# FQB25N33TM\_F085 330V N-Channel MOSFET

### Features

- 25A, 330V,  $R_{DS(on)} = 0.23\Omega @V_{GS} = 10V$
- Low gate charge (typical 58nC)
- Low Crss (typical 40pF)
- · Fast switching
- 100% avalanche tested
- Improved dv/dt capability
- Qualified to AEC Q101
- RoHS Compliant



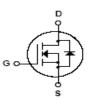
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D<sup>2</sup>-PAK FQB Series FQB25N33TM\_F085 330V N-Channel MOSFET

## **General Description**

These N-Channel enhancement mode power field effect transistors are produced using Farichild's proprietary, planar stripe, DMOS technology.

This advanced technology has been especially tailored to minimized on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficient switched mode power supplies, active power factor correction, electronic lamp ballast based on half bridge topology.



### Absolute Maximum Ratings

Symbol	Parameter	Ratings	Units	
V <sub>DSS</sub>	Drain-Source Voltage		330	V
	Drain Current - Continuous ( $T_C = 25^{\circ}C$ )		25	А
I <sub>D</sub>	- Continuous (T <sub>C</sub> = 100 <sup>o</sup> C)		16.0	А
I <sub>DM</sub>	Drain Current - Pulsed	(Note 1)	100	А
V <sub>GSS</sub>	Gate -Source Voltage		±30	V
E <sub>AS</sub>	Single Pulse Avalanche Energy	(Note 2)	370	mJ
I <sub>AR</sub>	Avalanche Current	(Note 1)	25	А
E <sub>AR</sub>	Repetitive Avalance Energy	(Note 1)	37	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	4.5	V/ns
	Power Dissipation ( $T_A = 25^{\circ}C$ ) *		3.1	W
P <sub>D</sub>	Power Dissipation ( $T_c = 25^{\circ}C$ )		250	W
	- Derate above 25°C		2.0	W/ºC
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature	-55 to +150	°C	
Τ <sub>L</sub>	Maximum lead temperature for soldering purposes, 1/8 from case for 5 seconds	300	°C	

### **Thermal Characteristics**

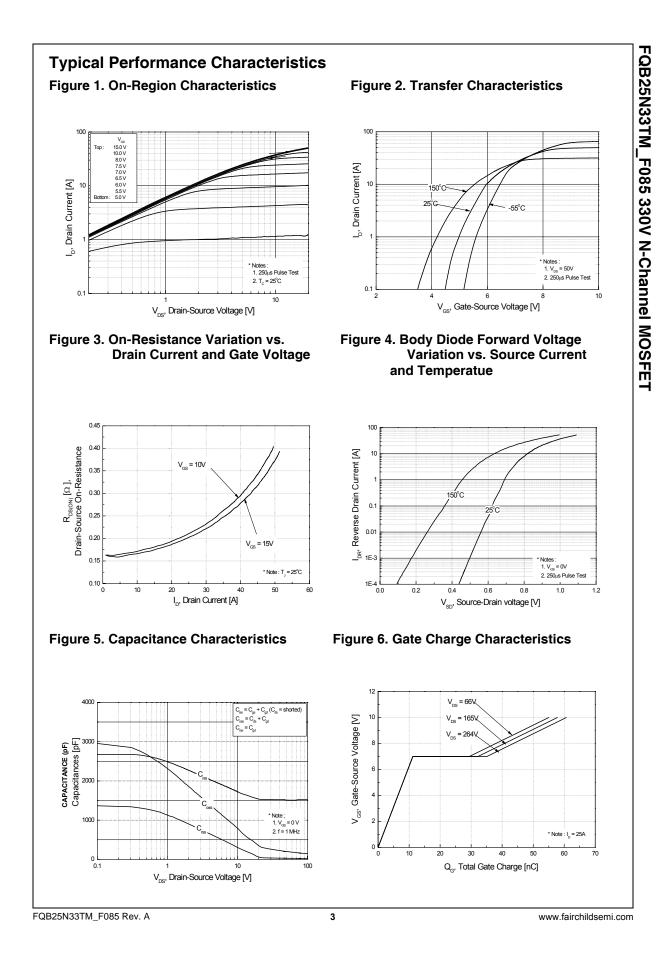
Symbol	Parameter	Ratings	Units
$R_{\theta JC}$	Thermal Resistance, Junction to Case	0.5	°C/W
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient *	40	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	62.5	°C/W

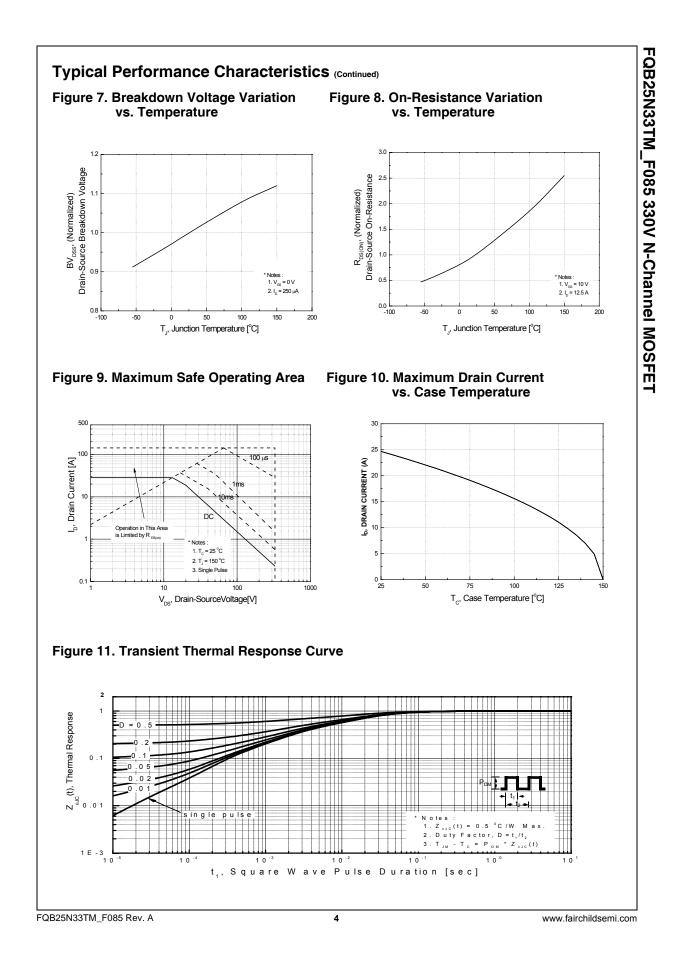
\* When mounted on the minimum pad size recommended (PCB Mount)

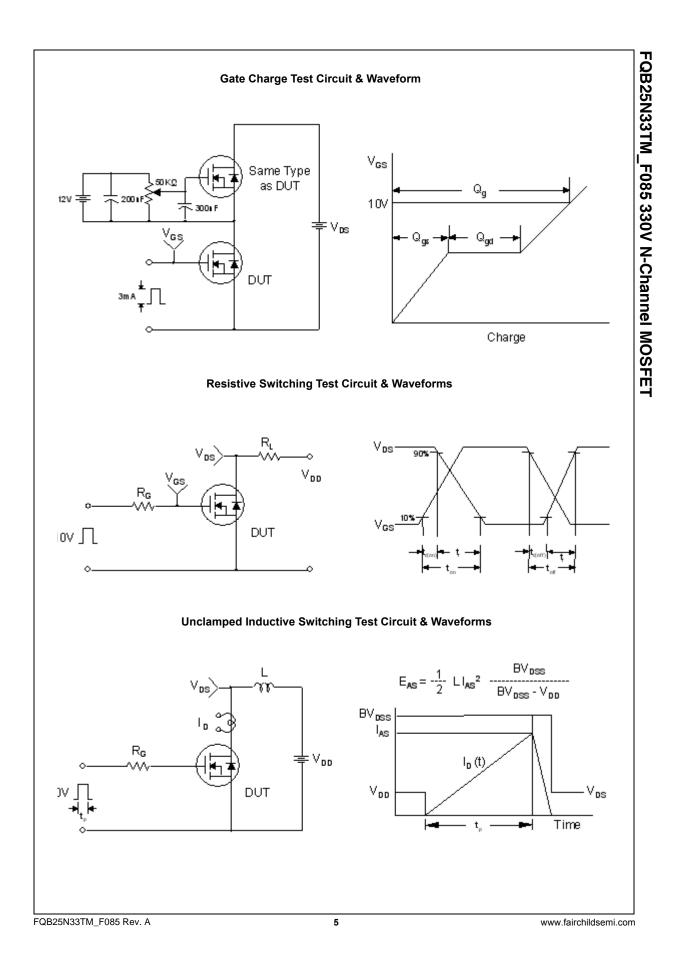
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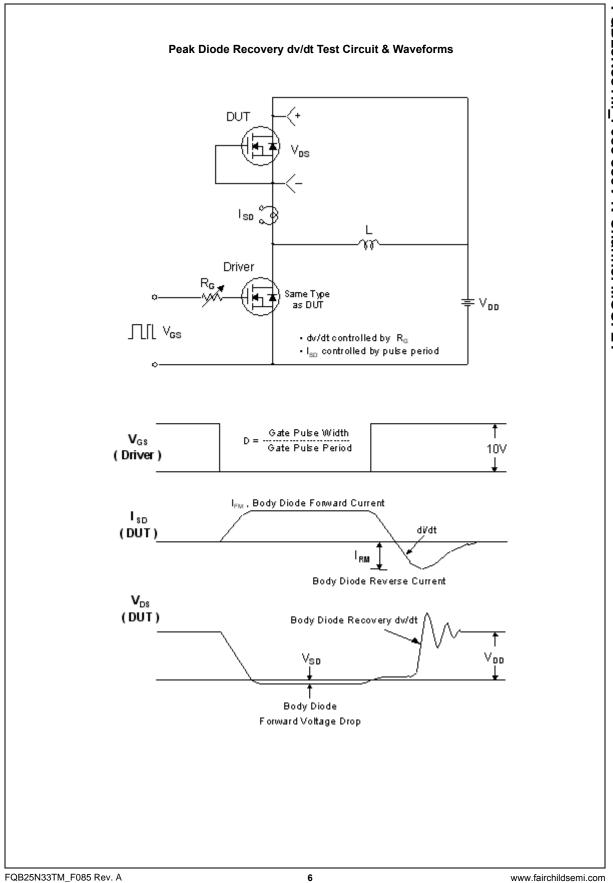
FQE	Marking	ing Device		Package Reel Size		Tape W	ape Width		Quantity	
	325N33	FQB25N33TM_F085	D	2-PAK	330mm	 24m	24mm		800	
Electri	cal Chara	acteristics T <sub>C</sub> = 2	5°C unle	ess otherwi	se noted					
Symbol Parameter			Test Conditions		Min	Тур	Max	Units		
Off Chara	cteristics									
B <sub>VDSS</sub>	Drain-Source	e Breakdown Voltage		ln = 250u	A, V <sub>GS</sub> = 0V	330			V	
$\Delta B_{VDSS} / \Delta T_{J}$			ature Coefficient $I_D = 250 \mu A$ , Referenced to 25°C			°C	0.34		V/°C	
I <sub>DSS</sub>	Zero Gate V	oltage Drain Current			)V,V <sub>GS</sub> = 0V 4V,T <sub>C</sub> =125°C			1 10	μ <b>A</b>	
IGSSF	Gate-Body L	eakage Current, Forward	d	$V_{GS} = 30$	$s = 30V, V_{DS} = 0V$			100	nA	
IGSSR	Gate-Body L	eakage Current, Forwar	d	0.0	$V, V_{DS} = 0V$			-100	nA	
On Charac	teristics							I	]	
V <sub>GS(th)</sub>	Gate Thresh	old Voltage		$V_{De} = V_{C}$	<sub>S</sub> , I <sub>D</sub> = 250μA	3.0		5.0	V	
R <sub>DS(on)</sub>		rce On Resistance			/, I <sub>D</sub> = 12.5A,		0.18	0.23	Ω	
9 <sub>FS</sub>		nsonductance			/, I <sub>D</sub> = 12.5A, (Note	4)	1		S	
	Characteristics			1						
C <sub>iss</sub>	Input Capaci			Vns = 25	V, V <sub>GS</sub> = 0V,		1510	2010	pF	
C <sub>oss</sub>	Output Capa	f = 1.0MHz				290	385	pF		
		nsfer Capacitance					40	60	pF	
t <sub>d(on)</sub>	Characteristic Turn-On Dela	s ay Time		Vpp = 165	5V. In = 25A		20	35	ns	
Switching ( t <sub>d(on)</sub> t <sub>r</sub>	Characteristic Turn-On Dela Turn-On Rise	s ay Time e Time		V <sub>DD</sub> = 165 R <sub>GS</sub> = 259	5V, I <sub>D</sub> = 25Α		20 100	35 160	ns ns	
Switching ( t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub>	Characteristic Turn-On Dela Turn-On Rise Turn-Off Dela	s ay Time e Time ay Time				  5)	20 100 90	35 160 145	ns ns ns	
Switching ( t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub>	Characteristic Turn-On Dela Turn-On Rise Turn-Off Dela Turn-Off Fall	s ay Time e Time ay Time Time		R <sub>GS</sub> = 259	Ω (Note 4, 5	  5) 	20 100 90 70	35 160 145 110	ns ns ns ns	
Switching ( t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g(TOT)</sub>	Characteristic Turn-On Dela Turn-On Rise Turn-Off Dela Turn-Off Fall Total Gate C	s ay Time e Time ay Time Time harge		R <sub>GS</sub> = 259 V <sub>DS</sub> = 297	Ω (Note 4, 5 7V, I <sub>D</sub> = 25A,	  5)  	20 100 90 70 58	35 160 145 110 75	ns ns ns nS nC	
Switching ( t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub>	Characteristic Turn-On Dela Turn-On Rise Turn-Off Dela Turn-Off Fall Total Gate C	s ay Time e Time ay Time Time harge ce Gate Charge		R <sub>GS</sub> = 259	Ω (Note 4, 5 7V, I <sub>D</sub> = 25A,	  5)   	20 100 90 70	35 160 145 110	ns ns ns ns	
Switching ( t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g(TOT)</sub> Q <sub>gs</sub> Q <sub>gd</sub>	Characteristic Turn-On Dela Turn-On Rise Turn-Off Dela Turn-Off Fall Total Gate C Gate to Sour Gate to Drair	s ay Time e Time ay Time Time harge ce Gate Charge	m Ratin	R <sub>GS</sub> = 259 V <sub>DS</sub> = 297 V <sub>GS</sub> = 151	Ω (Note 4, 5 7V, I <sub>D</sub> = 25A, V,	  5)   	20 100 90 70 58 11.2	35 160 145 110 75 	ns ns ns nC nC	
Switching ( t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g(TOT)</sub> Q <sub>gs</sub> Q <sub>gd</sub> Drain-Sour	Characteristic Turn-On Dela Turn-On Rise Turn-Off Dela Turn-Off Fall Total Gate C Gate to Sour Gate to Drair	s ay Time e Time ay Time Time harge ce Gate Charge n Charge		$R_{GS} = 259$ $V_{DS} = 297$ $V_{GS} = 15$	Ω (Note 4, 5 7V, I <sub>D</sub> = 25A, V, (Note 4, 5	  5)   	20 100 90 70 58 11.2	35 160 145 110 75 	ns ns ns nC nC	
Switching ( t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g(TOT)</sub> Q <sub>gs</sub> Q <sub>gd</sub> Drain-Sour	Characteristic Turn-On Dela Turn-On Rise Turn-Off Dela Turn-Off Fall Total Gate C Gate to Sour Gate to Drair rce Diode Cha Maximum Co	s ay Time e Time ay Time Time harge ce Gate Charge n Charge aracteristics and Maximu	Diode Fo	$R_{GS} = 259$ $V_{DS} = 297$ $V_{GS} = 151$ gs	Ω (Note 4, 5 7V, I <sub>D</sub> = 25A, V, (Note 4, 5	  5)   5)	20 100 90 70 58 11.2 21	35 160 145 110 75  	ns ns ns nC nC nC	
Switching ( t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g(TOT)</sub> Q <sub>gs</sub> Q <sub>gd</sub> Drain-Sour	Characteristic Turn-On Dela Turn-On Rise Turn-Off Dela Turn-Off Fall Total Gate C Gate to Sour Gate to Drair rce Diode Cha Maximum Cc Maximum Pu	s ay Time e Time ay Time Time harge ce Gate Charge n Charge aracteristics and Maximu ontinuous Drain-Source I	Diode Fo e Forwa	$R_{GS} = 259$ $V_{DS} = 297$ $V_{GS} = 151$ gs	Ω (Note 4, 5 7V, I <sub>D</sub> = 25A, V, (Note 4, 5 rent	    5)      	20 100 90 70 58 11.2 21	35 160 145 110 75   25	ns ns ns nC nC nC	
Switching ( t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g(TOT)</sub> Q <sub>gs</sub> Q <sub>gd</sub> Drain-Sour I <sub>S</sub> I <sub>SM</sub>	Characteristic Turn-On Dela Turn-On Rise Turn-Off Dela Turn-Off Fall Total Gate C Gate to Sour Gate to Drair rce Diode Cha Maximum Cc Maximum Pu	s ay Time e Time ay Time Time harge ce Gate Charge n Charge aracteristics and Maximu ontinuous Drain-Source I ulsed Drain-Source Diode e Diode Forward Voltage	Diode Fo e Forwa	$R_{GS} = 259$ $V_{DS} = 297$ $V_{GS} = 15V$ gs prward Cur rd Current	$\Omega \qquad (Note 4, 5)$ $7V, I_D = 25A,$ $V, \qquad (Note 4, 5)$ rent $S = 25A$	    5)      	20 100 90 70 58 11.2 21 	35 160 145 110 75   25 100	ns ns ns nC nC nC nC	

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